

## SI4484EY-T1-E3-VB Datasheet N-Channel 100 V (D-S) MOSFET

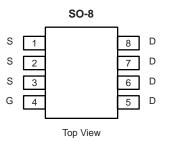
PRODUCT SUMMARY				
V <sub>DS</sub>	100	V		
$R_{DS(on)}$ $V_{GS} = 10$ V	32	mΩ		
I <sub>D</sub>	9	А		
Configuration	Single			

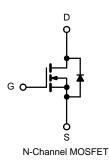
#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- Extremely Low Q<sub>gd</sub> for Switching Losses
- 100 % R<sub>g</sub> Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

• Primary Side Switch





<b>ABSOLUTE MAXIMUM RATIN</b>	<b>IGS</b> (T <sub>A</sub> = 25 °C	, unless othe	erwise noted)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	100	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
	T <sub>C</sub> = 25 °C		9	
	T <sub>C</sub> = 70 °C	1 , T	6	
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	6 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	1 f	5 <sup>b, c</sup>	Α
Pulsed Drain Current		I <sub>DM</sub>	40	A
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		7	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	Is	3.8 <sup>b, c</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	30	
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	112	mJ
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		14	
	T <sub>C</sub> = 70 °C		5	w
	$T_{A} = 25 \text{ °C}$	P <sub>D</sub>	4 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C	1 1	2 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, †</sup>	t ≤ 10 s	R <sub>thJA</sub>	33	40	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	17	21	C/W	

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.



RoHS COMPLIANT HALOGEN FREE Available

## SI4484EY-T1-E3-VB

B	<sup>®</sup> VBsemi			
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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	100			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			172			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 10		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.0		3.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Olata Malla na Dira'a Orana di		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	DSS	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			A	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		32		mΩ	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		33			
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5 A		20		S	
Dynamic <sup>b</sup>					•	<b></b>	
Input Capacitance	C <sub>iss</sub>			1900			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		150		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
Total Gate Charge	Q <sub>g</sub> -	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		28.5	43	nC	
				23	35		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 8 \text{ V}, I_{D} = 5 \text{ A}$		8			
Gate-Drain Charge	Q <sub>qd</sub>			6.5			
Gate Resistance	R <sub>q</sub>	f = 1 MHz		0.80	1.3	Ω	
Turn-on Delay Time	t <sub>d(on)</sub>			14	21		
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 10 \Omega$		12	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		22	33		
Fall Time	t <sub>f</sub>			6	10		
Turn-On Delay Time	t <sub>d(on)</sub>			16	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_{L}$ = 10 $\Omega$		12	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$		20	30		
Fall Time	t <sub>f</sub>			7	12		
Drain-Source Body Diode Characteristi	cs				•		
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			7.7	^	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2.6 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			63	95	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			110	165	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		49			
Reverse Recovery Rise Time	t <sub>b</sub>			14		ns	

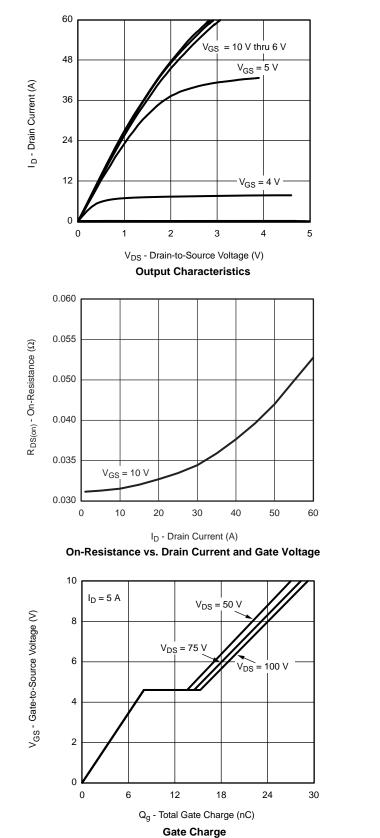
Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

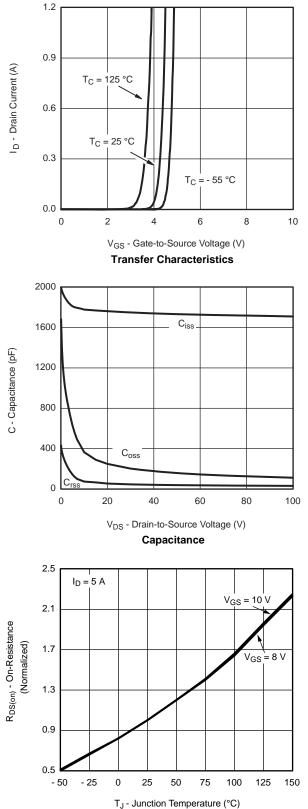
a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

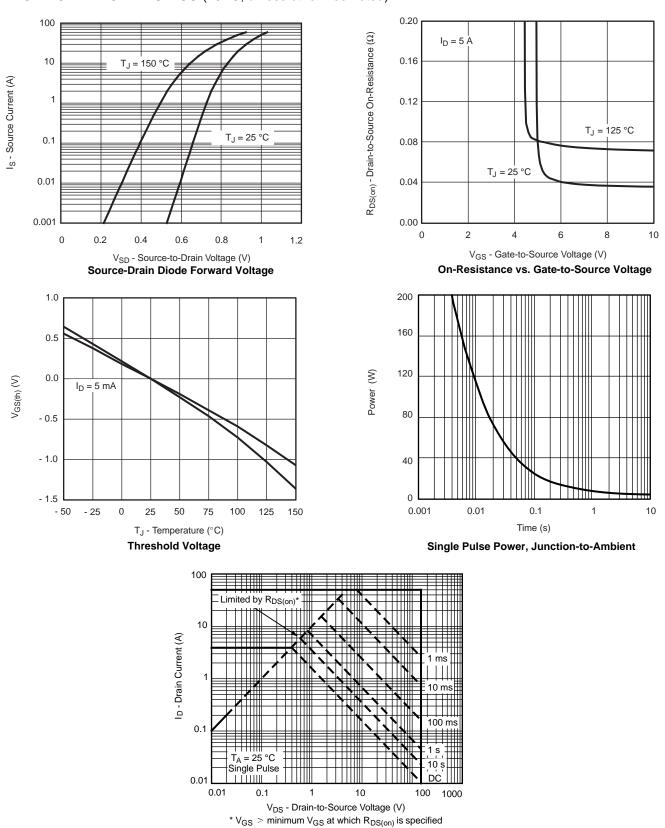


**On-Resistance vs. Junction Temperature** 

服务热线:400-655-8788

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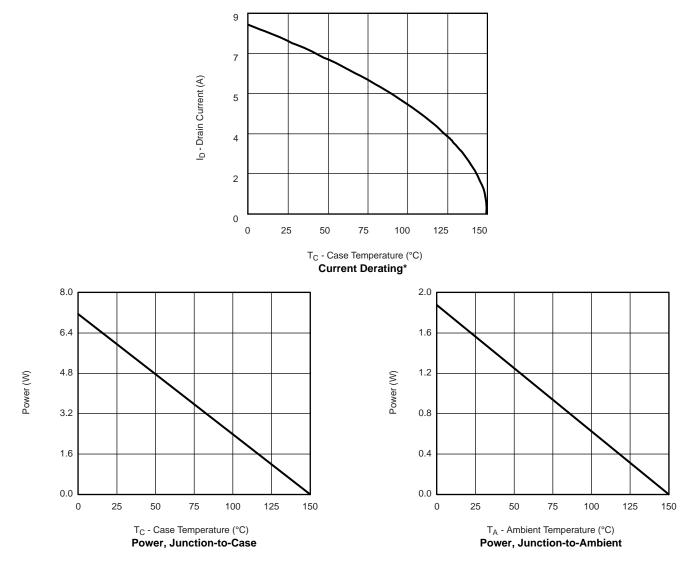
Safe Operating Area, Junction-to-Ambient

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

服务热线:400-655-8788



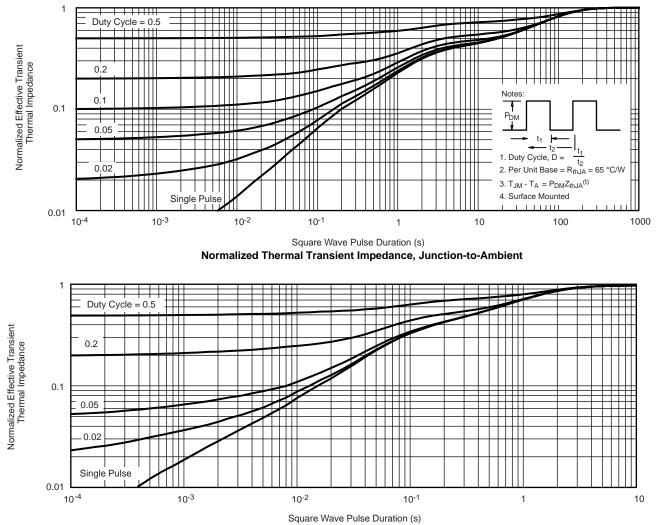
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



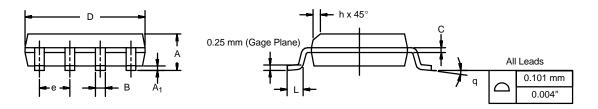
Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

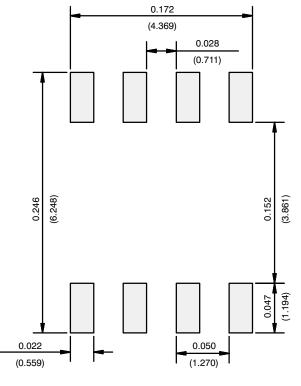




	MILLIMETERS		INC	HES	
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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